PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Dae Young LEE	03/21/2005
Jin Koo LIM	03/21/2005
Hyun Ki MOON	03/21/2005

RECEIVING PARTY DATA

Name:	WHIZEN GLOBAL CO., LTD.	
Street Address:	#302 Kyu-seok Building, 657-84 Hannam-dang	
Internal Address:	Yongsan-gu	
City:	Seoul	
State/Country:	KOREA, REPUBLIC OF	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	11053806

CORRESPONDENCE DATA

Fax Number: (515)558-7790

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Phone: 515 558-0200

Email: tzarley@zarleylaw.com

Correspondent Name: ZARLEY LAW FIRM, P.L.C.

Address Line 1: 400 Locust Street

Address Line 2: Capital Square, Suite 200
Address Line 4: Des Moines, IOWA 50309-2350

NAME OF SUBMITTER: TIMOTHY J. ZARLEY

Total Attachments: 3

source=Assignment#page1.tif source=Assignment (2)#page1.tif source=Assignment (3)#page1.tif

PATENT

REEL: 015998 FRAME: 0232

JP \$40.00 110

500030810

ASSIGNMENT

	In consideration of One Dollar and other good and	
	valuable considerations, the receipt and sufficiency	
	whereof are hereby acknowledged, the undersigned hereby	
	assigns to Whizen Global Co., Ltd.	
	a Korean corporation, having an address of	
#	302 Kyu-seok Bullding, 657-84 Hannam-dong, Yongsan-gu, Seoul, Republic of Korea	
	its successors and assigns the entire right, title and	
	interest in the invention or improvements of the	
	undersigned disclosed in an application for Letters	
	Patent of the United States, Serial No. 11/053,806	
	filed in the United States Patent and Trademark Office or	
	the 9th day of February , 2005 ,	
	entitled	
METHOD AND APPARATUS FOR EVAPORATIVE COOLING OF A COOLING FLUID		
	and in said application any and all other applications	
	for United States Letters Patent, which the undersigned	
	may file, either solely or jointly with others, on said	
	invention or improvements, and in any and all Letters	
	Patent, applications, and in any reissue or extension	
	thereof.	
	The undersigned hereby authorizes and requests the	

Commissioner of Patents to issue said Letters Patent to said Whizen Global Co., Ltd.

For said considerations the undersigned hereby

agree, upon the request, and at the expense of said assignee, its successors and assigns, to execute any and all divisional continuation and substitute applications PATENT for said invention or improvements, and REPL negset PRAME: 0233

oath or affidavit relating thereto, and any application for the reissue or extension of any Letters Patent that may be granted upon said application, and for the said considerations the undersigned further agree upon the request of said assignee, its successors or assigns, in the event of any application or Letters Patent assigned herein becoming involved in interference, to cooperate to the best of the ability of the undersigned with said assignee, its successors or assigns in the matters of preparing and executing the preliminary statement and giving and producing evidence in support thereof, the undersigned hereby agreeing to perform, upon request, any and all affirmative acts to obtain said Letters Patent of the United States and vest all rights therein hereby conveying in the said assignee, its successors and assigns whereby said Letters Patent will be held and enjoyed by the said assignee, its successors and assigns to the full end of the term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by the undersigned if this assignment and sale had not been made.

The attorneys of record are hereby authorized to insert the serial number and the filing date in the above blank spaces when received from the Patent Office.

Dae Young LEE
Dae Young LEE

Dated: March 21, 2005

Jin Koo Lim

Dated: March 21, 2005

My Killoon

Hyun Ki MOON

Dated: March 21, 2005

PATENT

REEL: 015998 FRAME: 0235